

CLAIMS

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1. Assembly including a printed-circuit electronics card (2) mounted on a metal substrate (1), as well as a metal screening cover (3) electrically connected to the substrate (1), the substrate (1) exhibiting a recessed gutter (4) in which the edge of the cover (3) is accommodated, characterised in that the said edge is crimped onto the said substrate (1) in the gutter (4).
2. Assembly according to Claim 1, characterised in that the edge of the cover (3) terminates in at least one tab (5) as a return, which is crimped into the gutter (4).
3. Assembly according to Claim 2, characterised in that the bottom of the said gutter (4) and the said tab (5) are below the electronics card (2).
4. Method for producing an assembly according to one of the preceding claims, characterised by the following different stages:
- the substrate (1) is stamped so as to form a gutter (4) in it,
 - the electronics card (2) is assembled onto the said substrate,
 - the cover (3) is positioned on the assembly thus obtained, arranging the edge of the said cover (3) in the said gutter (4),
 - the said edge is crimped onto the said substrate (1).
5. Method according to the preceding claim, characterised in that the crimping is carried out by localised crushing of material of the substrate (1) onto one or more tabs which terminate the edge of the cover (3), in such a way as to exert opposed forces which cancel out on the tab or tabs (5).
6. Method according to one of Claims 4 and 5, characterised in that the stamping forms, at the edge of

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the gutter, a protuberance intended to constitute the material to be displaced during the crimping.

7. Method according to one of Claims 4 to 6, characterised in that only some of the tabs of the cover

5 (3) are crimped.

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